

600V 1.0 Ω Super Junction Power MOSFET

Description

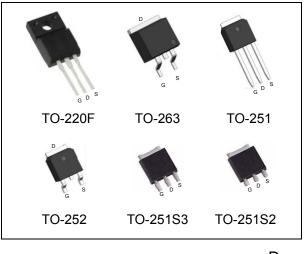
WMOSTM C2 is Wayon's 2nd generation super junction MOSFET family that is utilizing charge balance technology for extremely low on-resistance and low gate charge performance. WMOSTM C2 is suitable for applications which require superior power density and outstanding efficiency.

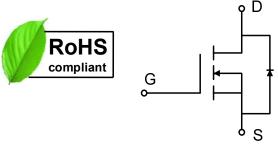
Features

- V_{DS} =650V @ T_{j,max}
- Typ. $R_{DS(on)} = 1.0\Omega$
- 100% UIS tested
- Pb-free plating, Halogen free



LED Lighting, Charger, Adapter, PC, LCD TV, Server





<u>Absol</u>	lute	Maximum	Ratings

Parameter	Symbol	WMH/WMM/WMO/WMP/WMG	WML	Unit
Drain-source voltage	V_{DSS}	600		V
Continuous drain current ¹⁾ $(T_C = 25^{\circ}C)$	I _D	5		Α
(T _C = 100°C)		3		Α
Pulsed drain current ²⁾	I _{DM}	9		Α
Gate-source voltage	V_{GS}	±30		V
Avalanche energy, single pulse ³⁾	E _{AS}	15		mJ
Avalanche energy, repetitive ²⁾	E _{AR}	0.1		mJ
Avalanche current, repetitive ²⁾	I _{AR}	0.7		Α
Power dissipation (T _C = 25°C)	P_{D}	42	23	W
- Derate above 25°C		0.34	0.18	W/°C
Operating and storage temperature range	T _i , T _{stg}	-55 to +150		°C
Continuous diode forward current	Is	5		А
Diode pulse current	I _{S,pulse}	9		Α

Thermal Characteristics

Parameter	Symbol	WMH/WMM/WMO/WMP/WMG	WML	Unit
Thermal resistance, junction-to-case	$R_{ heta JC}$	3	5.4	°C/W
Thermal resistance, junction-to-ambient	$R_{\theta JA}$	62	80	°C/W

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Electrical Characteristics T_c = 25°C, unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =0.25 mA	600	-	-	V
Gate threshold voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=0.25$ mA	2.5	3.3	4.5	V
Drain cut-off current	I _{DSS}	V _{DS} =600 V, V _{GS} =0 V,				μA
		T _j = 25°C	-	-	1	
		T _i = 125°C	-	10	-	
Gate leakage current, forward	I _{GSSF}	V _{GS} =30 V, V _{DS} =0 V	-	-	100	nA
Gate leakage current, reverse	I _{GSSR}	V _{GS} =-30 V, V _{DS} =0 V	-	-	-100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10 V, I _D =2A	-			
		T _i = 25°C	-	1.0	1.14	Ω
Dynamic characteristics						
Input capacitance	C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V,	-	270	-	
Output capacitance	Coss	f = 1 MHz	-	200	-	pF
Reverse transfer capacitance	C_{rss}		_	2	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 300V, I _D = 2A	-	5	-	
Rise time	t _r	$R_G = 25\Omega$, $V_{GS}=10V$	-	16	-	ns
Turn-off delay time	$t_{d(off)}$		-	24	-	
Fall time	t _f		_	12	-	
Gate charge characteristics						
Gate to source charge	Q_gs	V _{DD} =480 V, I _D =2A,	-	1.6	-	
Gate to drain charge	Q_gd	V _{GS} =0 to 10 V	_	1.7	-	nC
Gate charge total	Q_{g}		_	5.8	-	
Gate plateau voltage	V _{plateau}		_	5	-	V
Reverse diode characteristics						
Diode forward voltage	V_{SD}	V _{GS} =0 V, I _F =2A	-	-	1.2	V
Reverse recovery time	t _{rr}	V _R =50 V, I _F =2A,	-	163	-	ns
Reverse recovery charge	Q _{rr}	dl _F /dt=100 A/μs	-	0.84	-	μC
Peak reverse recovery current	I _{rrm}		-	10.3	-	Α

Notes:

- 1. Limited by $T_{j\,max}$. Maximum duty cycle D=0.5.
- 2. Repetitive rating: pulse width limited by maximum junction temperature
- 3. I_{AS} = 0.7A, V_{DD} = 50V, R_G = 25 Ω , starting T_j = 25 $^{\circ}C$

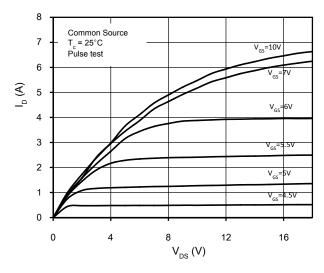


Figure 1.On-Region Characteristics

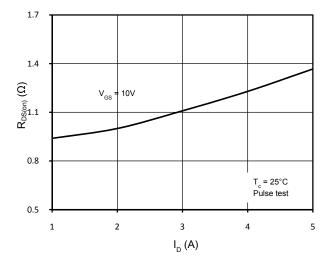


Figure 3. Static Drain-Source On Resistance

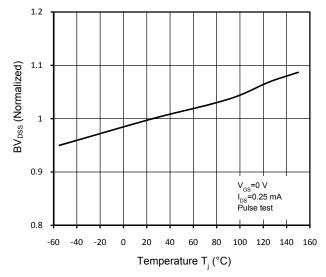


Figure 5. Normalized BV_{DSS} vs. Temperature

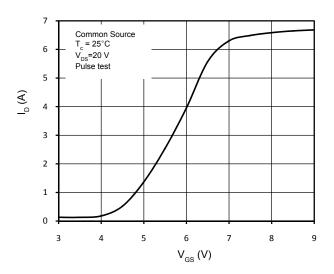


Figure 2. Transfer Characteristics

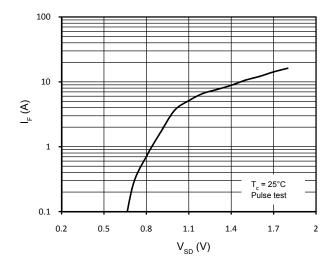


Figure 4. Body- Diode Forward Characteristics

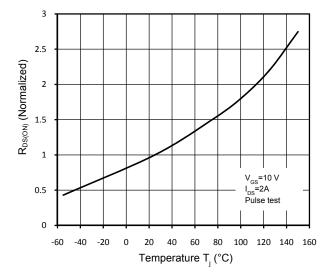


Figure 6. Normalized R_{DS(on)} vs. Temperature



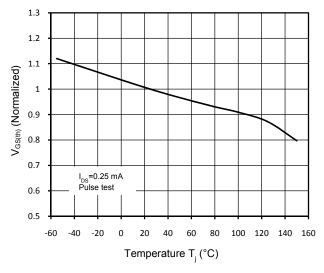


Figure 7. Threshold Voltage vs. Temperature

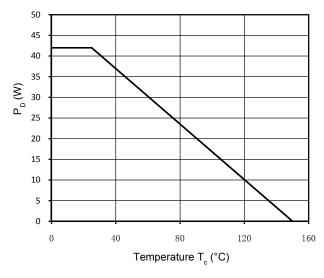


Figure 9. Power Dissipation

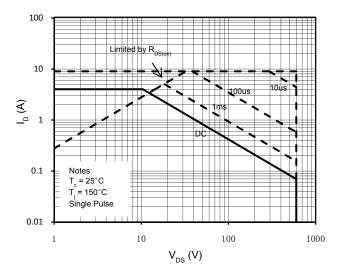


Figure 11. Maximum Safe Operating Area

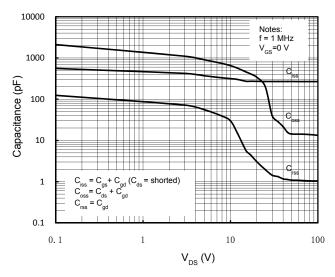


Figure 8. Capacitance Characteristics

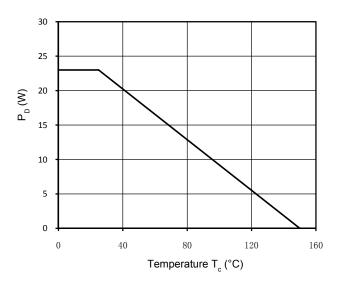


Figure 10. Power Dissipation (TO-220F)

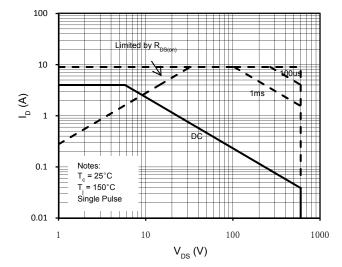


Figure 12. Maximum Safe Operating Area(TO-220F)



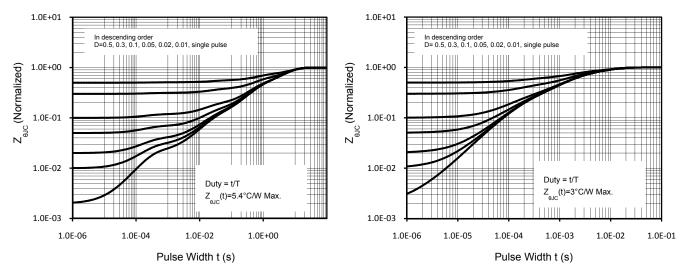


Figure 13. Transient Thermal Response Curve (TO-220F) Figure 14. Transient Thermal Response Curve

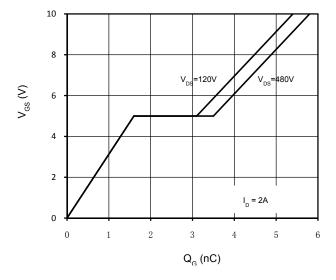
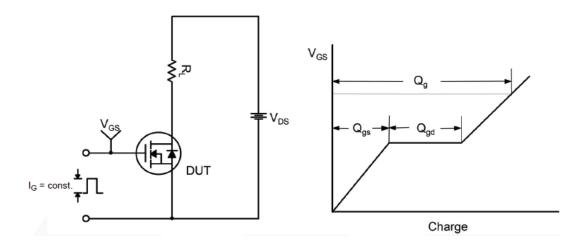


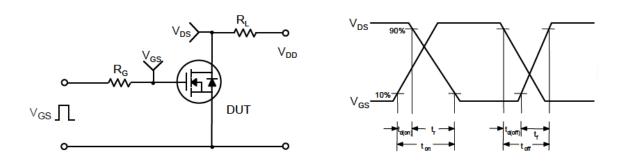
Figure 15. Gate Charge Characteristics



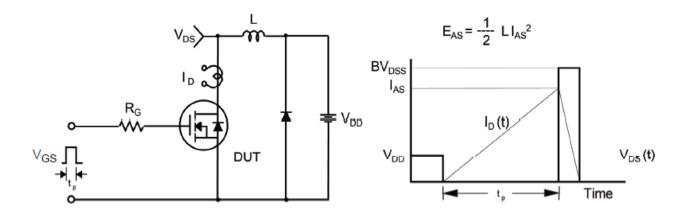
Gate Charge Test Circuit & Waveform



Switching Test Circuit & Waveforms

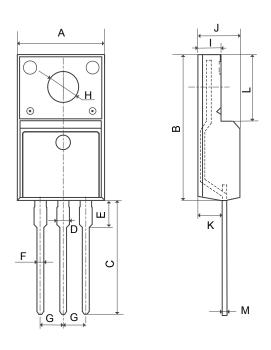


Unclamped Inductive Switching Test Circuit & Waveforms





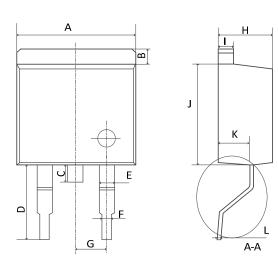
Mechanical Dimensions for TO-220F



COMMON DIMENSIONS

	MM		
SYMBOL	MIN	MAX	
Α	9.96	10.36	
В	15.67	16.07	
С	12.70	13.30	
D	1.12	1.32	
Е	1.85	2.15	
F	0.59	0.79	
G	2.39	2.69	
Н	3.08	3.29	
ı	2.34	2.74	
J	4.50	4.90	
K	2.61	2.91	
L	6.50	6.90	
М	0.40	0.60	

Mechanical Dimensions for TO-263

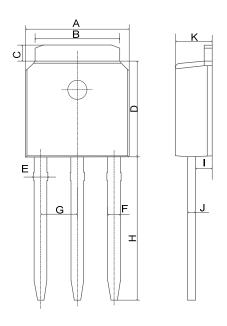


COMMON DIMENSIONS

	MM		
SYMBOL	MIN	MAX	
Α	10.00	10.40	
В	1.11	1.41	
С	1.25	1.55	
D	5.10	5.50	
E	1.12	1.42	
F	0.71	0.92	
G	2.39	2.69	
Н	4.49	4.89	
I	1.17	1.37	
J	8.45	8.85	
K	2.54 2.84		
L	0.28	0.49	



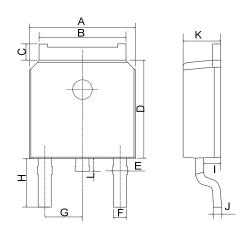
Mechanical Dimensions for TO-251



COMMON DIMENSIONS

0.4.50	MM		
SYMBOL	MIN	MAX	
Α	6.40	6.80	
В	5.13	5.46	
С	0.88	1.28	
D	5.90	6.22	
E	0.68	1.10	
F	0.68	0.91	
G	2.29	PREF	
Н	9.00	9.65	
I	0.90	1.17	
J	0.40	0.61	
K	2.10	2.50	

Mechanical Dimensions for TO-252

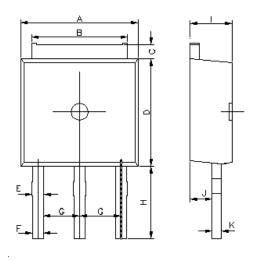


COMMON DIMENSIONS

	MM		
SYMBOL	MIN	MAX	
Α	6.40	6.80	
В	5.13	5.50	
С	0.88	1.28	
D	5.90	6.22	
E	0.68	1.10	
F	0.68	0.91	
G	2.29REF		
Н	2.90	REF	
I	0.85	1.17	
J	0.51REF		
K	2.10	2.50	
L	0.40	1.00	



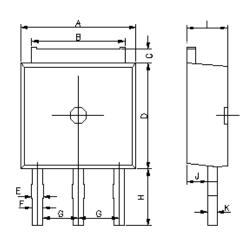
Mechanical Dimensions for TO-251S3



COMMON DIMENSIONS

	MM		
SYMBOL	MIN	MAX	
Α	6.40	6.80	
В	5.15	5.48	
С	0.71	1.02	
D	5.95	6.35	
E	0.70	1.00	
F	0.70	0.90	
G	2.13	2.44	
Н	3.20	3.80	
I	2.10	2.50	
J	0.85	1.15	
K	0.40	0.61	

Mechanical Dimensions for TO-251S2



COMMON DIMENSIONS

	MM		
SYMBOL	MIN	MAX	
Α	6.40	6.80	
В	5.15	5.48	
С	0.71	1.02	
D	5.95	6.35	
E	0.70	1.00	
F	0.70	0.90	
G	2.13	2.44	
Н	2.20	2.80	
I	2.10	2.50	
J	0.85	1.15	
K	0.40	0.61	

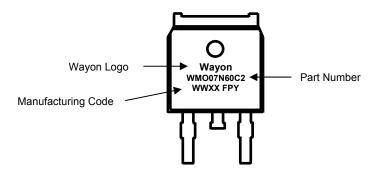
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Ordering Information

Part	Package	Marking	Packing method
WML07N60C2	TO-220F	WML07N60C2	Tube
WMM07N60C2	TO-263	WMM07N60C2	Tape and Reel
WMO07N60C2	TO-252	WMO07N60C2	Tape and Reel
WMP07N60C2	TO-251	WMP07N60C2	Tube
WMG07N60C2	TO-251S3	WMG07N60C2	Tube
WMH07N60C2	TO-251S2	WMH07N60C2	Tube

Marking Information



Contact Information

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WAYON website: http://www.way-on.com

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